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Class	Subclass
ISSUE CLASSIFICATION	

PATENT NUMBER

U.S. UTILITY Patent Application

122 O.I.P.E. PDY 84
SCANNED 450 O.A. 7M

PATENT DATE

APPLICATION NO. 09/994395	CONT/PRIOR	CLASS 257	SUBCLASS 758	ART UNIT 2811	EXAMINER TH. Muzee
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APPLICANTS

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Method of using ternary copper alloy to obtain a low resistance and large grain size interconnect

PTO-2040
12/99

ISSUING CLASSIFICATION

ORIGINAL				CROSS REFERENCE(S)								
CLASS		SUBCLASS		CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)							
INTERNATIONAL CLASSIFICATION												

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig. 4	Total Claims
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner) _____ (Date)		NOTICE OF ALLOWANCE MAILED	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____			ISSUE FEE	
			Amount Due	Date Paid
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			ISSUE BATCH NUMBER	
	_____ (Legal Instruments Examiner) _____ (Date)			

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